

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE (π -MOSV)

2SK2965

HIGH SPEED, HIGH VOLTAGE SWITCHING APPLICATIONS
SWITCHING REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE
APPLICATIONS

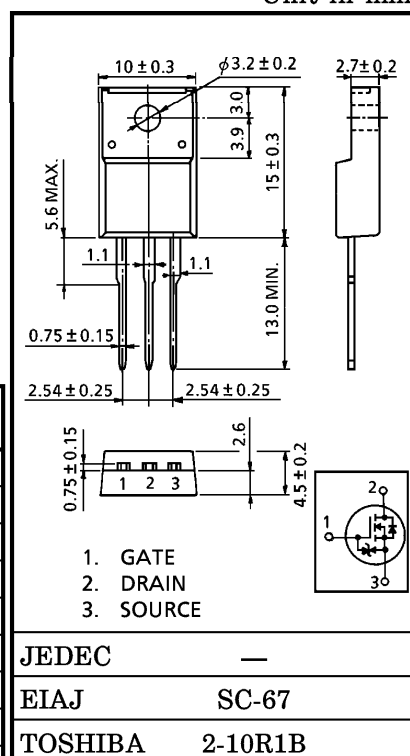
INDUSTRIAL APPLICATIONS

Unit in mm

- Low Drain-Source ON Resistance : $R_{DS(ON)} = 0.15 \Omega$ (Typ.)
- High Forward Transfer Admittance : $|Y_{fs}| = 10 S$ (Typ.)
- Low Leakage Current : $I_{DSS} = 100 \mu A$ (Max.) ($V_{DS} = 200 V$)
- Enhancement-Mode : $V_{th} = 1.5 \sim 3.5 V$ ($V_{DS} = 10 V$, $I_D = 1 mA$)

MAXIMUM RATINGS ($T_a = 25^\circ C$)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DSS}	200	V
Drain-Gate Voltage ($R_{GS} = 20 k\Omega$)	V_{DGR}	200	V
Gate-Source Voltage	V_{GSS}	± 20	V
Drain Current	DC	I_D	11
	Pulse	I_{DP}	33
Drain Power Dissipation ($T_a = 25^\circ C$)	P_D	35	W
Single Pulse Avalanche Energy**	E_{AS}	115	mJ
Avalanche Current	I_{AR}	11	A
Repetitive Avalanche Energy*	E_{AR}	3.5	mJ
Channel Temperature	T_{ch}	150	$^\circ C$
Storage Temperature Range	T_{stg}	$-55 \sim 150$	$^\circ C$



THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th(ch-c)}$	3.57	$^\circ C/W$
Thermal Resistance, Channel to Ambient	$R_{th(ch-a)}$	62.5	$^\circ C/W$

Note ;

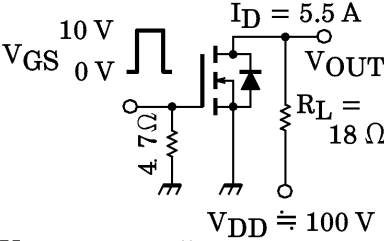
* Repetitive rating ; Pulse Width Limited by Max. junction temperature.

** $V_{DD} = 50 V$, $T_{ch} = 25^\circ C$ (initial), $L = 1.53 mH$, $R_G = 25 \Omega$, $I_{AR} = 11 A$ **This transistor is an electrostatic sensitive device.****Please handle with caution.**

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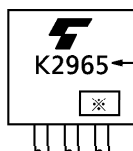
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I_{GSS}	$V_{GS} = \pm 16 \text{ V}$, $V_{DS} = 0 \text{ V}$	—	—	± 10	μA
Drain Cut-off Current		I_{DSS}	$V_{DS} = 200 \text{ V}$, $V_{GS} = 0 \text{ V}$	—	—	100	μA
Gate-Source Breakdown Voltage		$V_{(BR)DSS}$	$I_D = 10 \text{ mA}$, $V_{GS} = 0 \text{ V}$	200	—	—	V
Gate Threshold Voltage		V_{th}	$V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$	1.5	—	3.5	V
Drain-Source ON Resistance		$R_{DS(ON)}$	$V_{GS} = 10 \text{ V}$, $I_D = 5.5 \text{ A}$	—	0.15	0.26	Ω
Forward Transfer Admittance		$ Y_{fs} $	$V_{DS} = 10 \text{ V}$, $I_D = 5.5 \text{ A}$	5.0	10	—	S
Input Capacitance		C_{iss}	$V_{DS} = 10 \text{ V}$, $V_{GS} = 0 \text{ V}$ $f = 1 \text{ MHz}$	—	1200	—	pF
Reverse Transfer Capacitance		C_{rss}		—	100	—	
Output Capacitance		C_{oss}		—	290	—	
Switching Time	Rise Time	t_r	 $I_D = 5.5 \text{ A}$ $V_{GS} = 10 \text{ V}$, 0 V 4.7Ω $R_L = 18 \Omega$ $V_{DD} \approx 100 \text{ V}$	—	15	—	ns
	Turn-on Time	t_{on}		—	25	—	
	Fall Time	t_f		—	10	—	
	Turn-off Time	t_{off}		—	75	—	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Q_g	$V_{DD} \approx 100 \text{ V}$, $V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}$	—	30	—	nC
Gate-Source Charge		Q_{gs}		—	20	—	
Gate-Drain ("Miller") Charge		Q_{gd}		—	10	—	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I_{DR}	—	—	—	11	A
Pulse Drain Reverse Current	I_{DRP}	—	—	—	33	A
Diode Forward Voltage	V_{DSF}	$I_{DR} = 11 \text{ A}$, $V_{GS} = 0 \text{ V}$	—	—	—2.0	V
Reverse Recovery Time	t_{rr}	$I_{DR} = 11 \text{ A}$, $V_{GS} = 0 \text{ V}$	—	175	—	ns
Reverse Recovery Charge	Q_{rr}	$dI_{DR}/dt = 100 \text{ A}/\mu\text{s}$	—	1.3	—	μC

MARKING



TYPE

※ Lot Number



Month (Starting from Alphabet A)



Year (Last Number of the Christian Era)